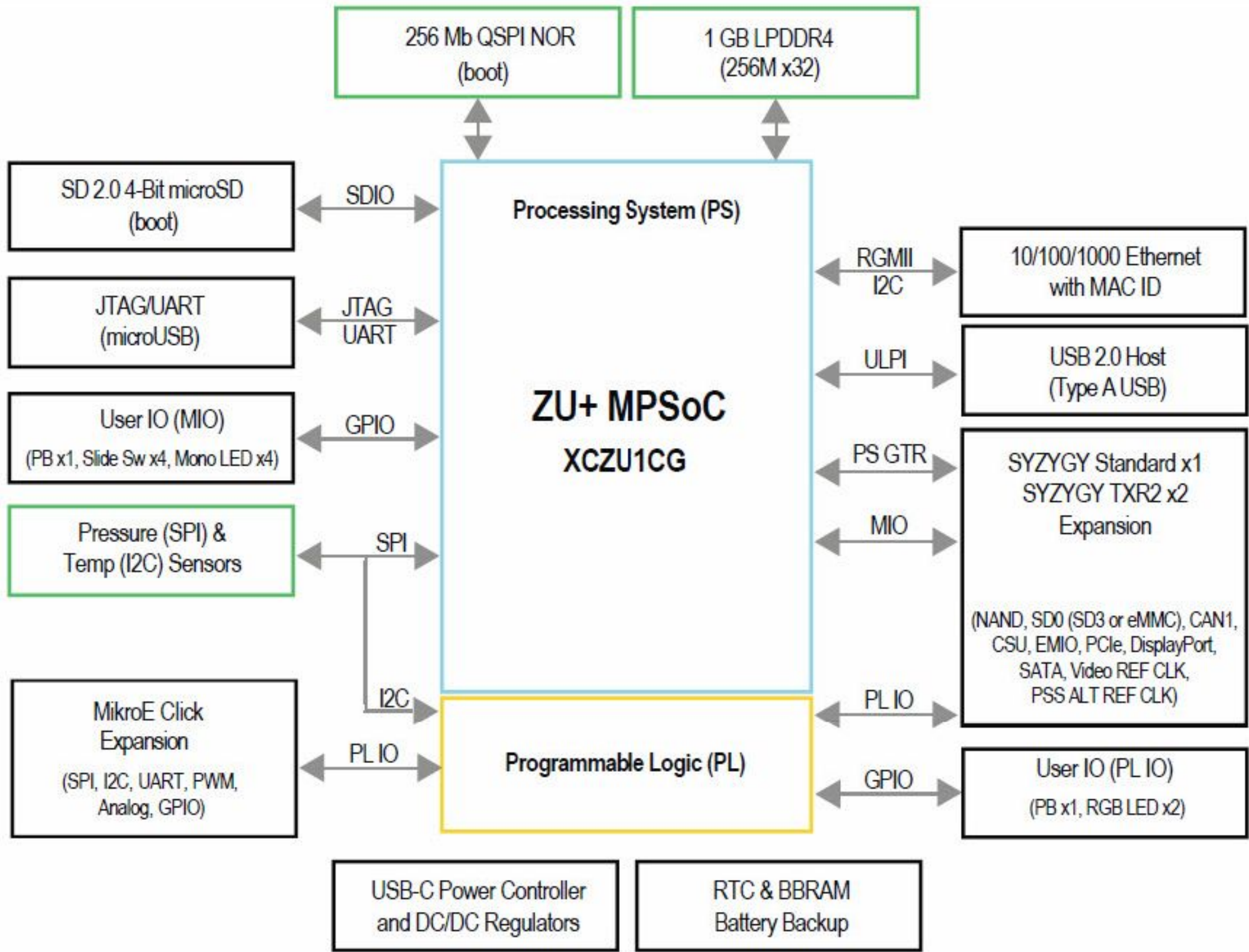
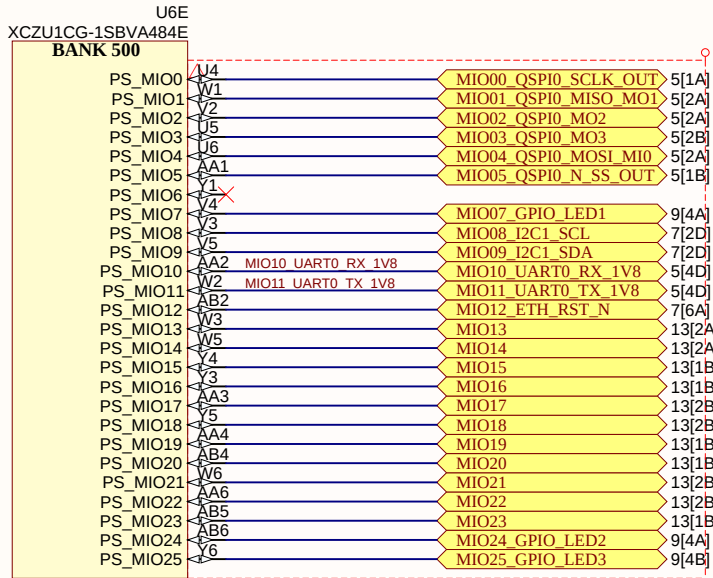


Block Diagram



BANK 500, BANK 501, BANK 502, BANK 503

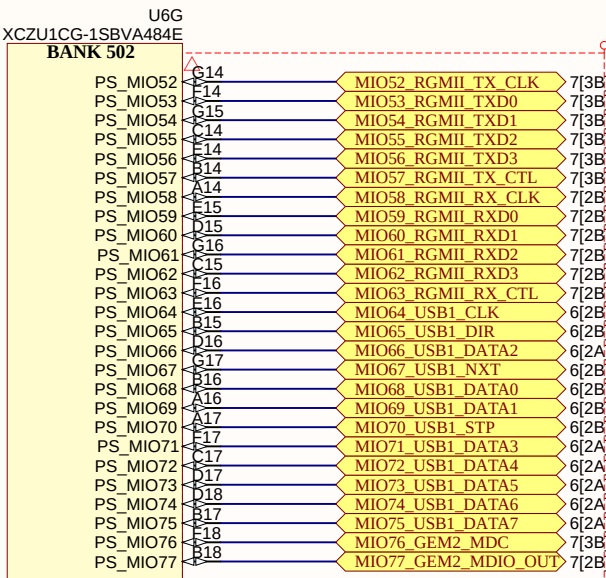
BANK 500



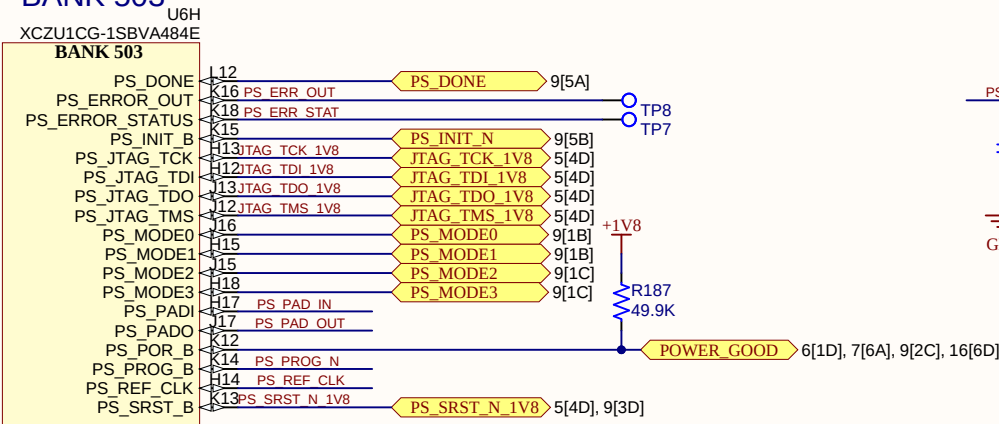
BANK 501



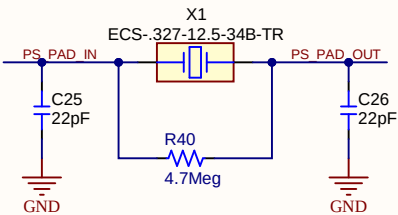
BANK 502



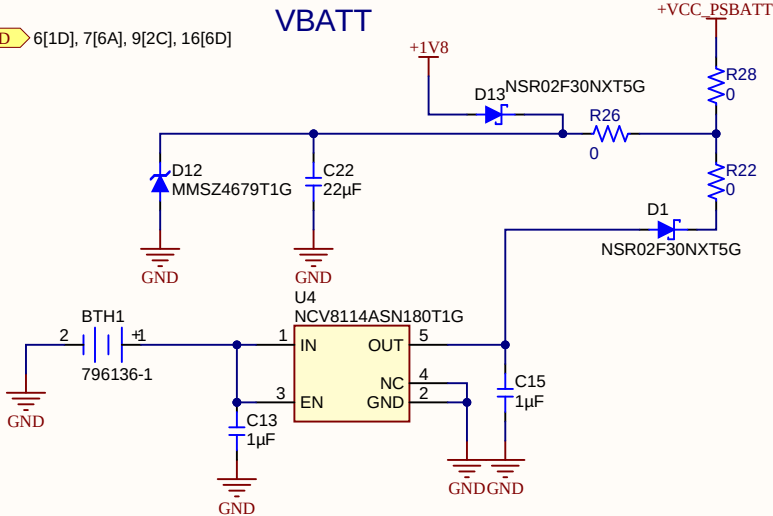
BANK 503



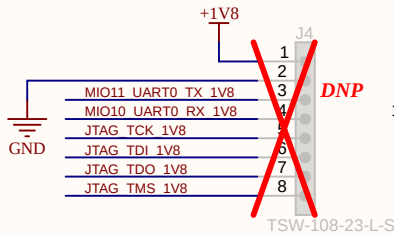
32KHz RTC XTAL



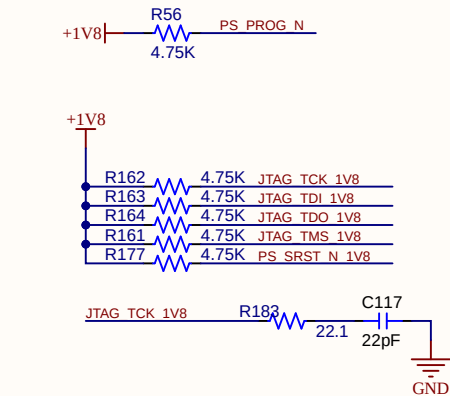
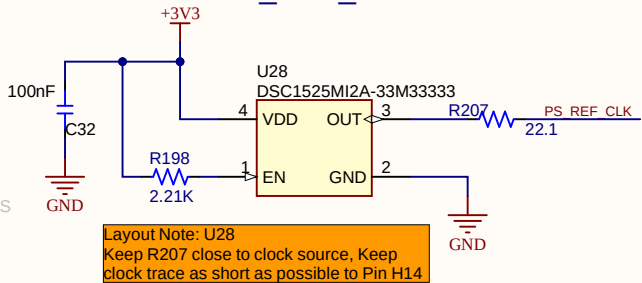
VBATT



JTAG/UART Connector

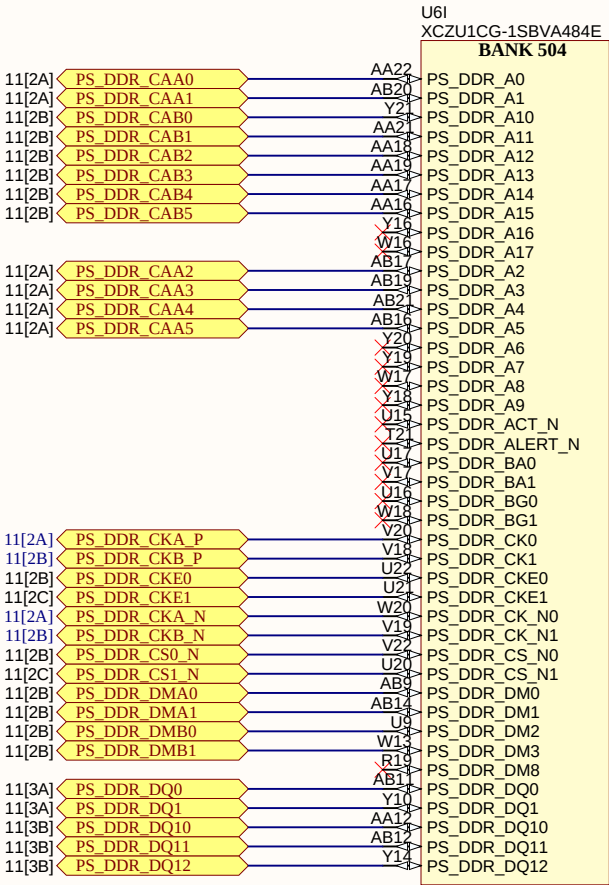


PS_REF_CLK

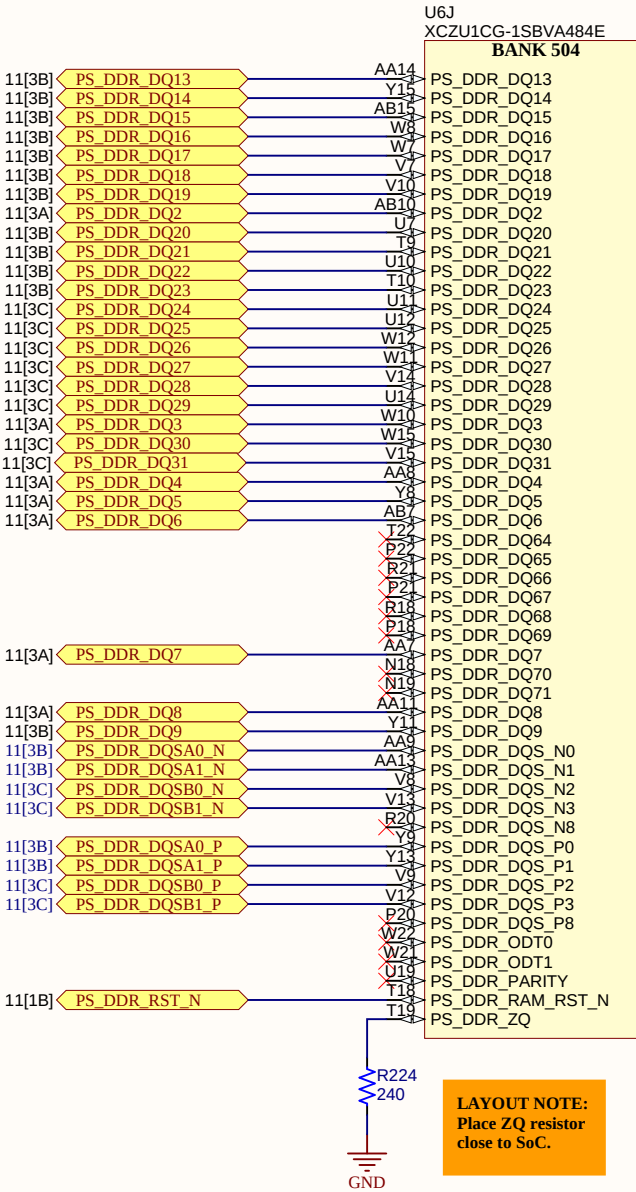


BANK 504, BANK 505

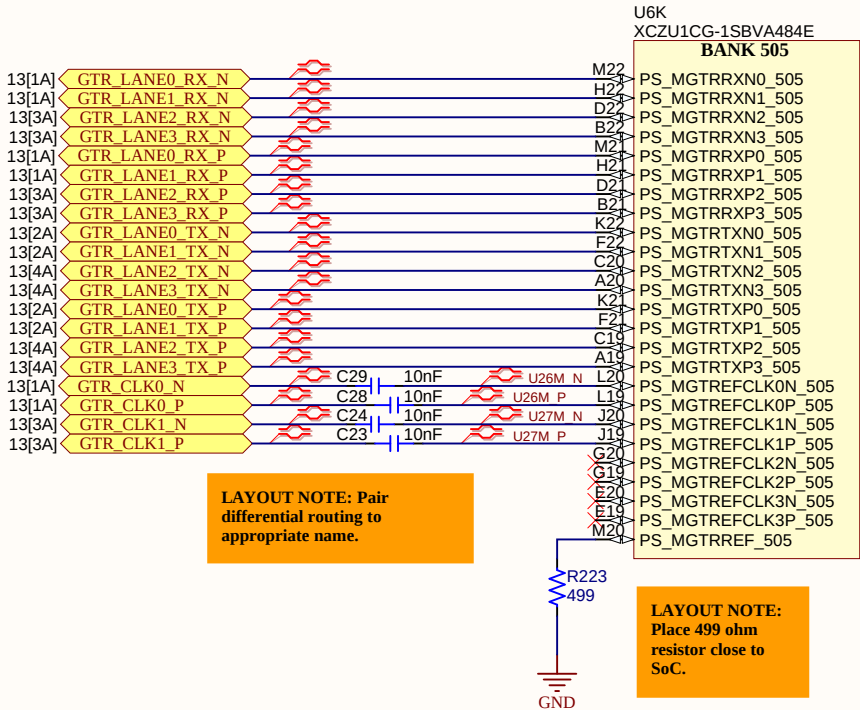
BANK 504 - DDR



BANK 504 - DDR



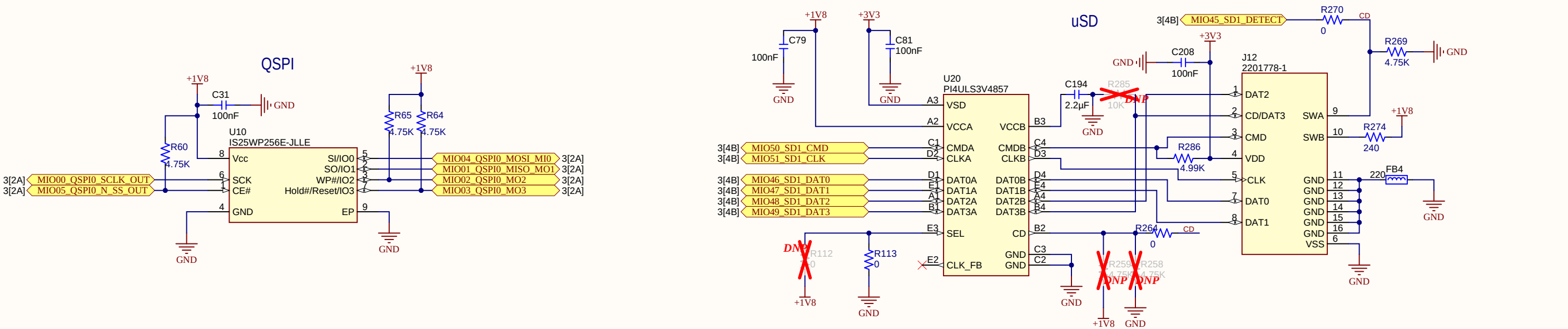
BANK 505 - GTR



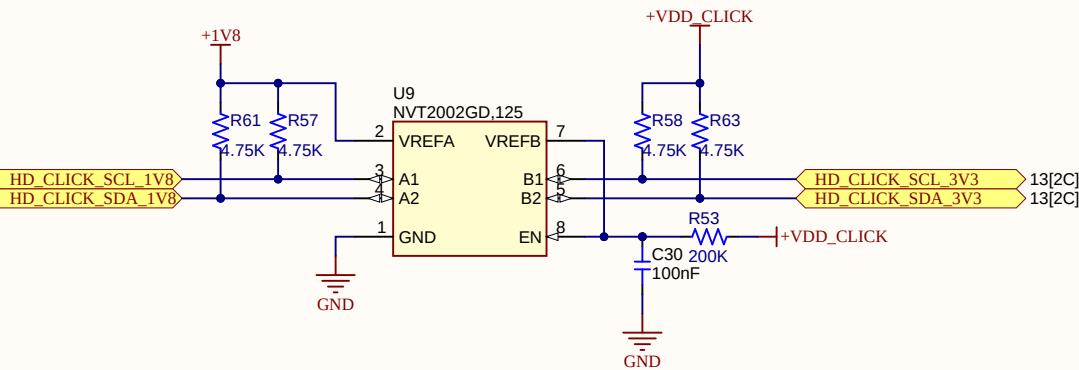
LAYOUT NOTE: Pair differential routing to appropriate name.

LAYOUT NOTE: Place 499 ohm resistor close to SoC.

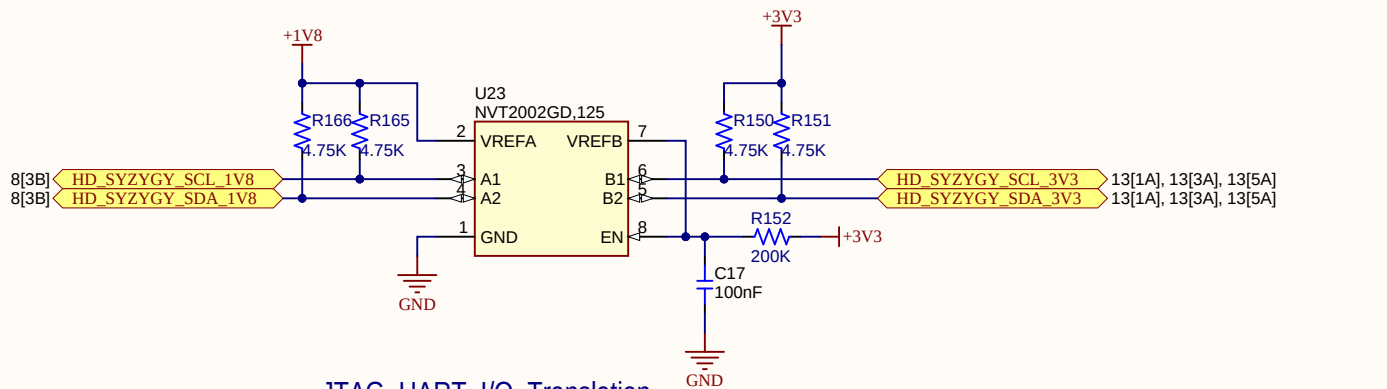
QSPI, uSD, and Voltage Translation



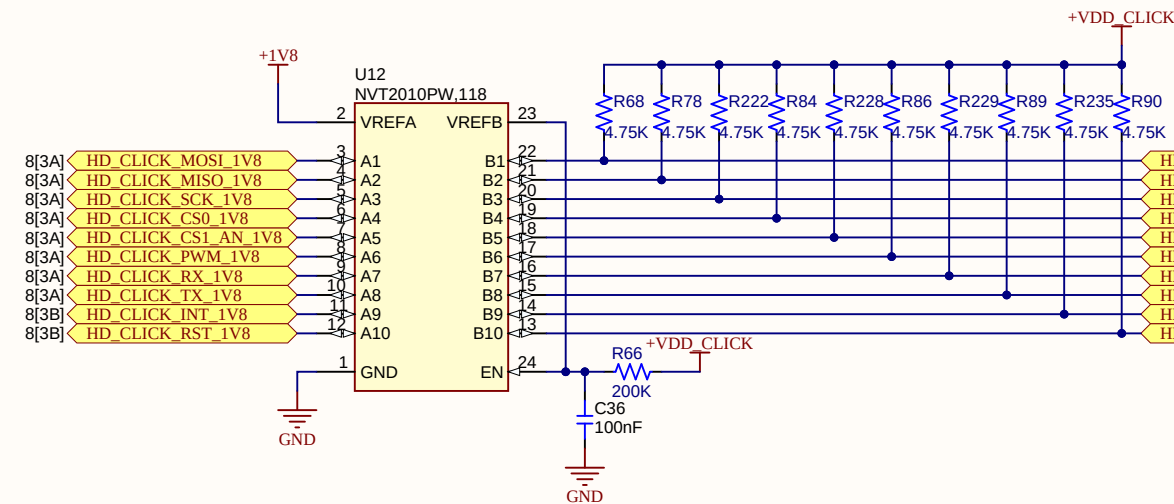
Click_I2C_I/O_Translation



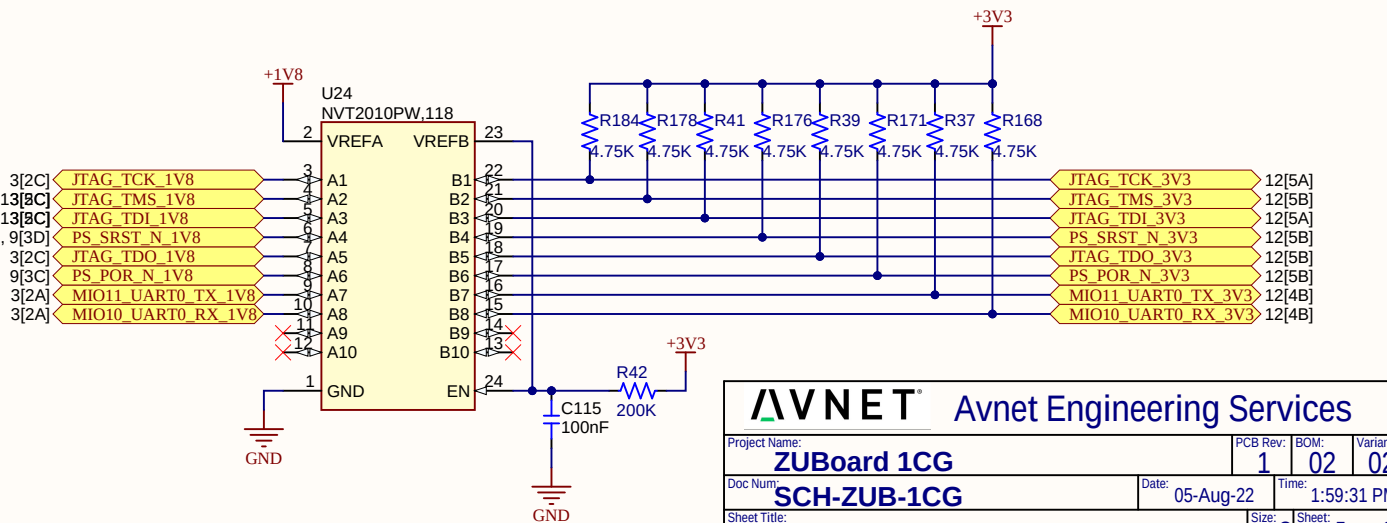
SZYGY_I2C_I/O_Translation



Click_I/O_Translation

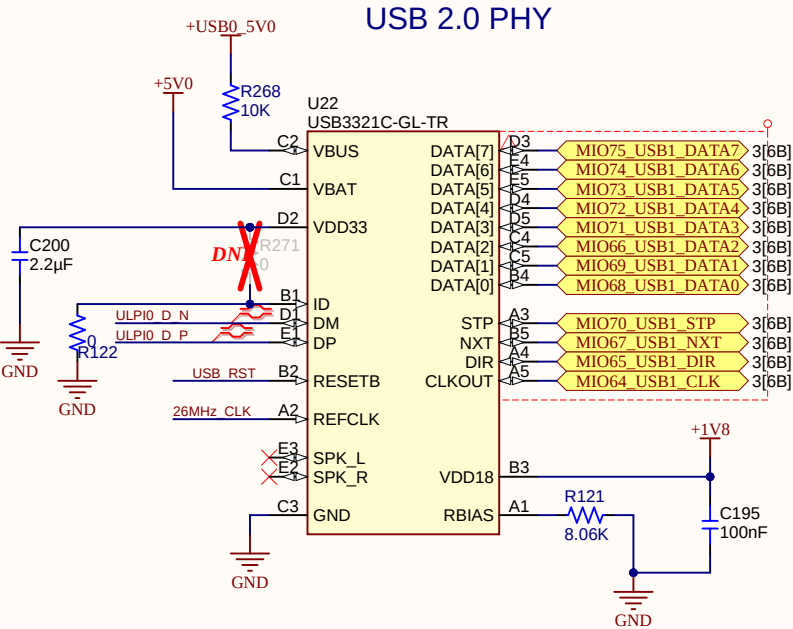


JTAG_UART_I/O_Translation

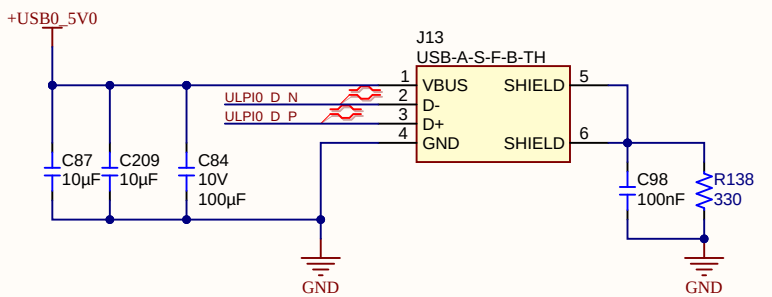


USB 2.0, JTAG/UART MicroUSB

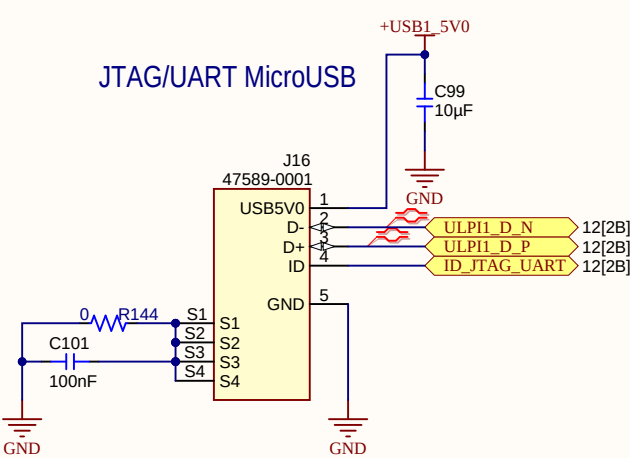
USB 2.0 PHY



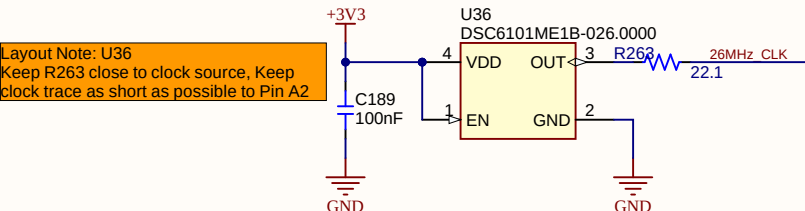
USB 2.0 Type A Connector



JTAG/UART MicroUSB

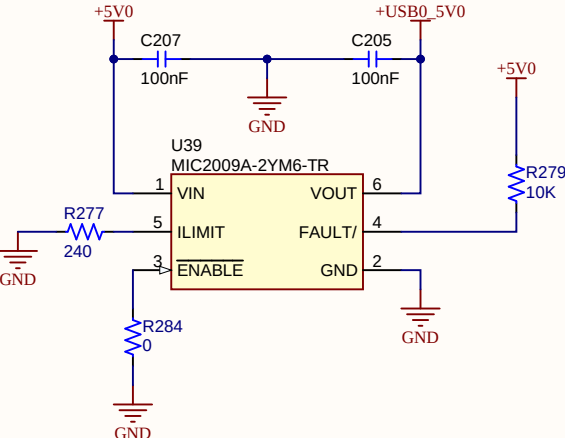


26MHz Clock

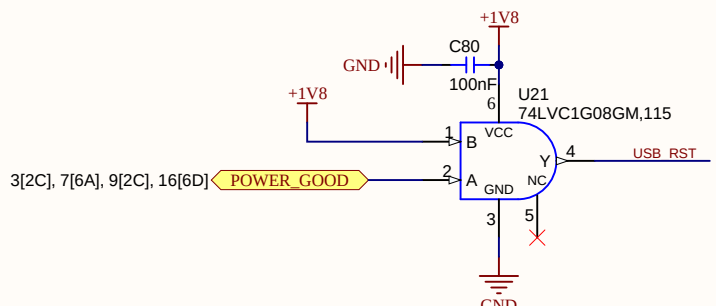


Layout Note: U36
Keep R263 close to clock source, Keep
clock trace as short as possible to Pin A2

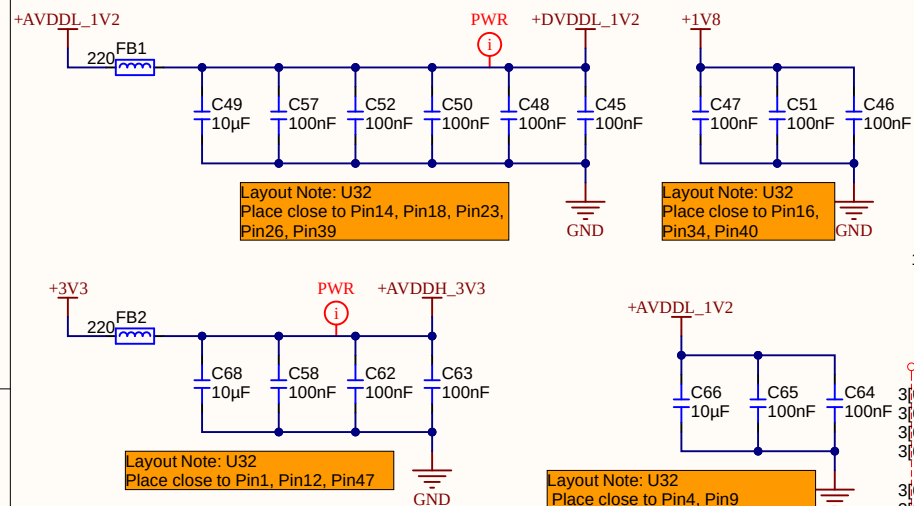
Over Current Fault 900mA



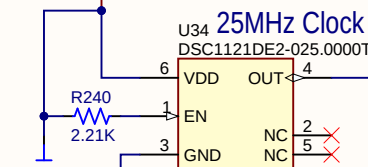
USB 2.0 PHY Reset



PHY Decoupling



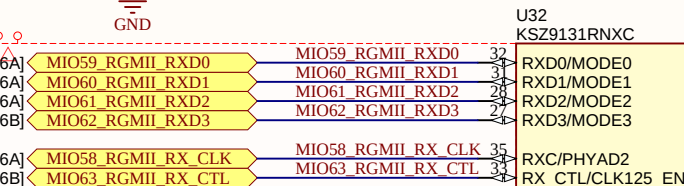
Layout Note: U18
Keep R249 close to clock source, Keep clock trace as short as possible to Pin 46



Ethernet 10/100/1000

Layout Note: U32
Pin 32, 31, 28, 27, 33, 35 to be length matched withing 20 mils and 50 Ohm

Ethernet PHY



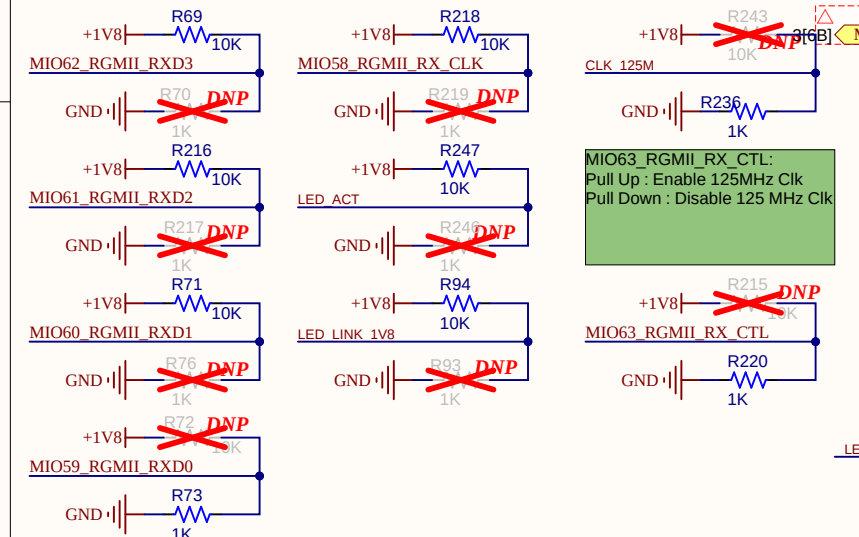
Strapping Options:

MODE: (D3,D2,D1,D0)
1110
RGMII MODE
10/100/1000M
1000M Full Duplex
100M/10M Half/Full Duplex

PHY Address:
(AD4, AD3), AD2, AD1, AD0
(00)111

LED MODE
LED MODE=1 & Pull Up -> Single-LED Mode
LED MODE=0 & Pull Down -> Tri-color LED Mode
LED MODE=0 & strap is unused -> Enhanced LED Mode

Layout Note: U32
Place R164 a close to PHY as possible
R250 = 6.04k for KSZ9131
R250 = 12.1k for KSZ9031



BANK44



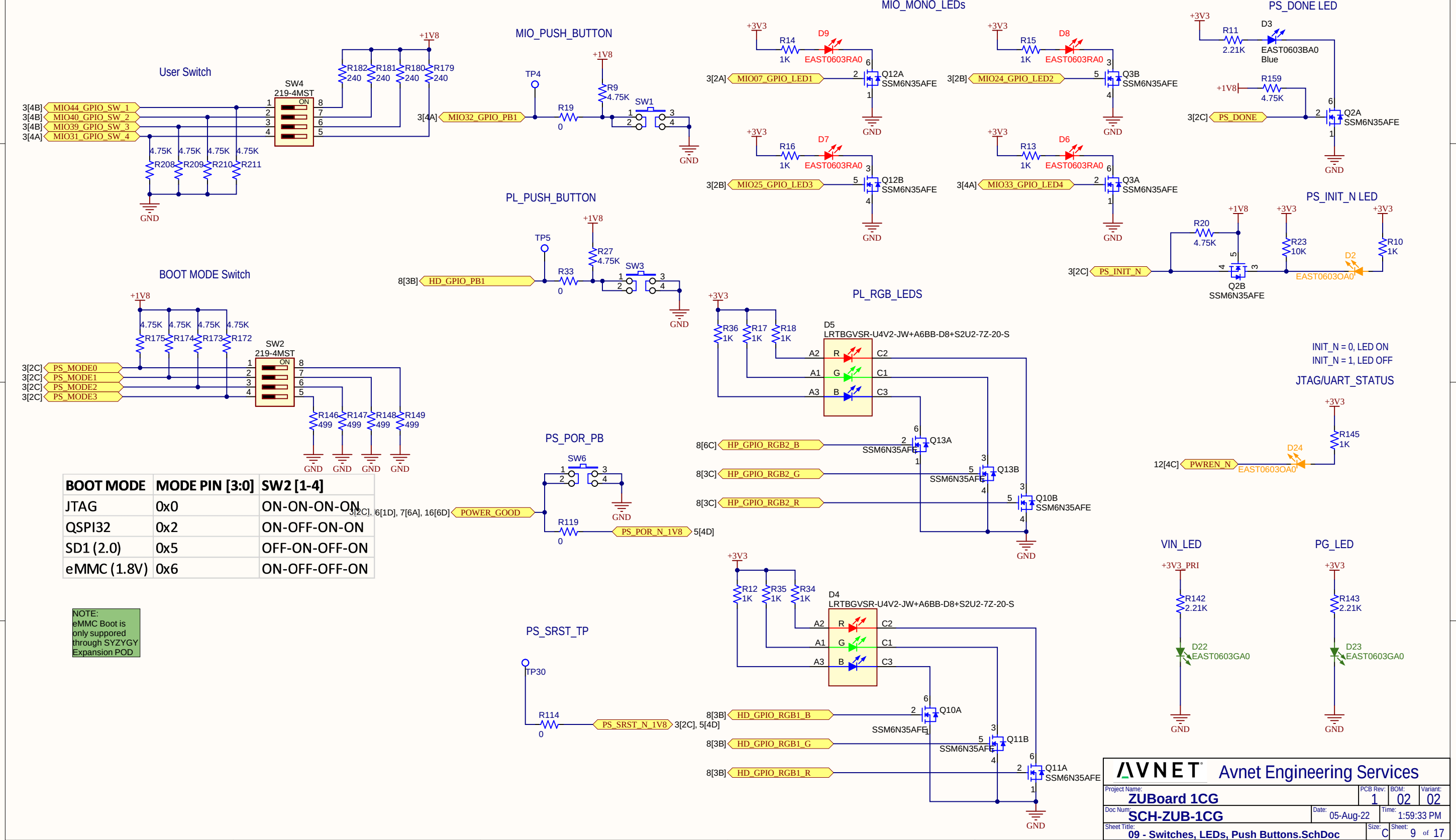
SWITCHES, LEDs, Push Buttons

Switches

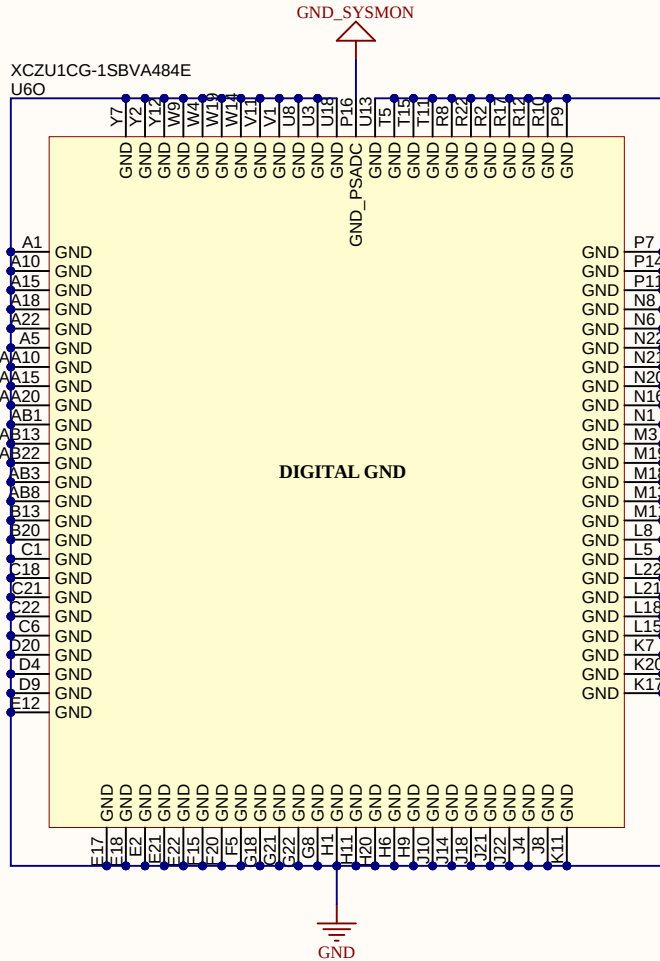
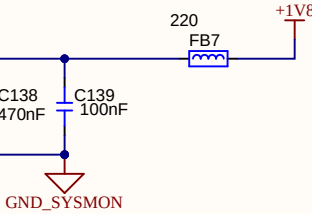
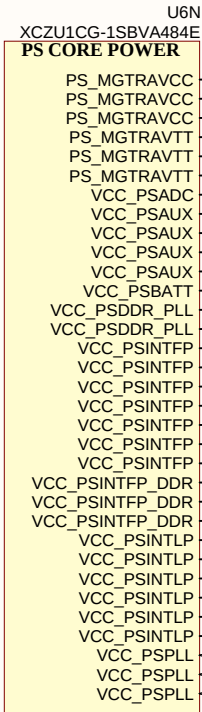
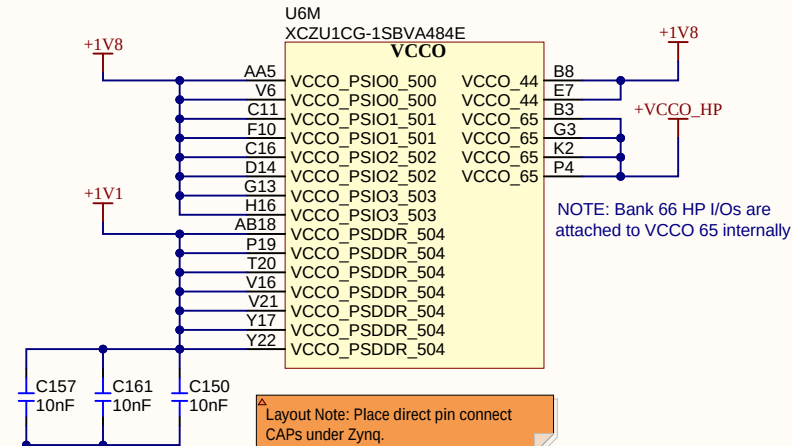
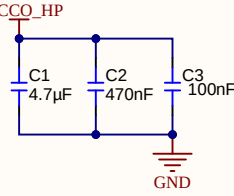
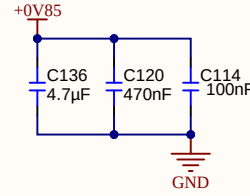
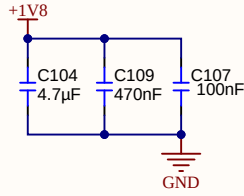
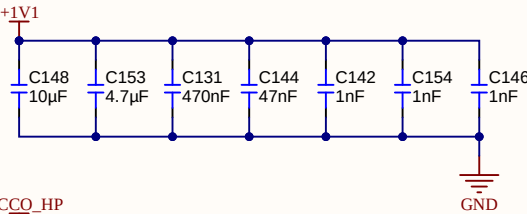
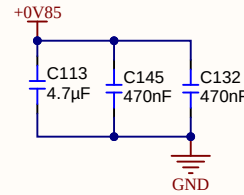
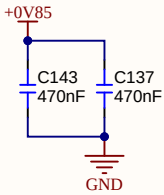
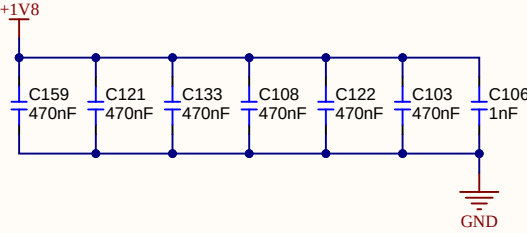
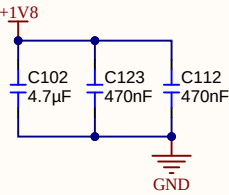
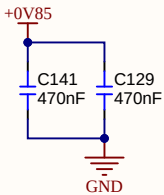
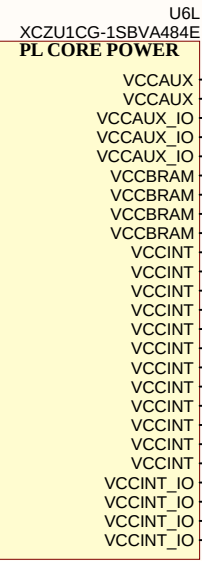
Push Buttons

User LEDs

LED INDICATORS:



BANK POWER & DECOUPLING



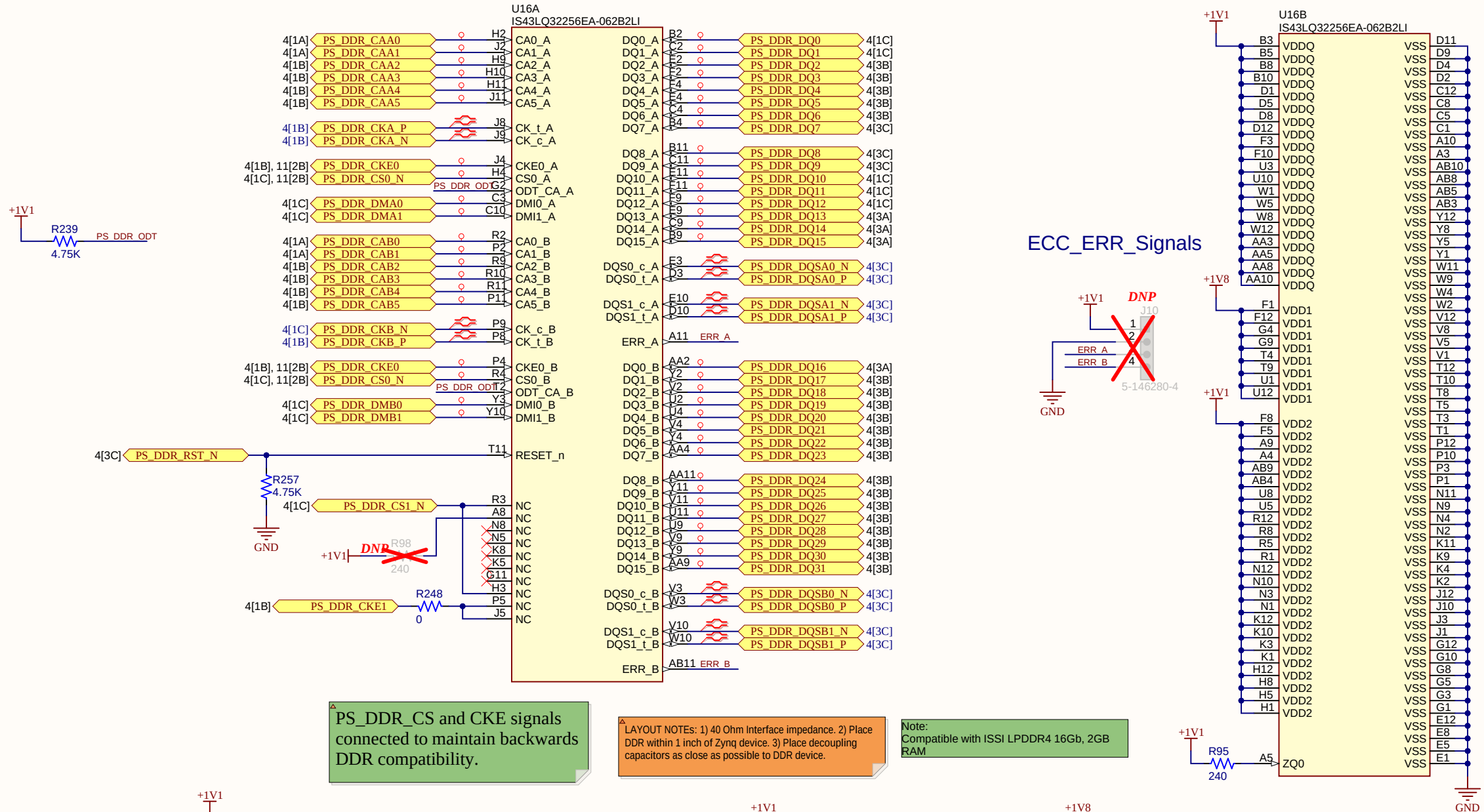
AVNET® Avnet Engineering Services

Project Name:	ZUBoard 1CG	PCB Rev:	BOM:	Variant:
Doc Num:	SCH-ZUB-1CG	Date:	05-Aug-22	Time: 1:59:34 PM
Sheet Title:	10 - Bank Power and Decoupling.SchDoc	Size:	C	Sheet: 10 of 17

LPDDR4 8Gb (1GB) RAM

POINT-TO-POINT: NO DDR TERM RESISTORS

40 OHM INTERFACE IMPEDANCE

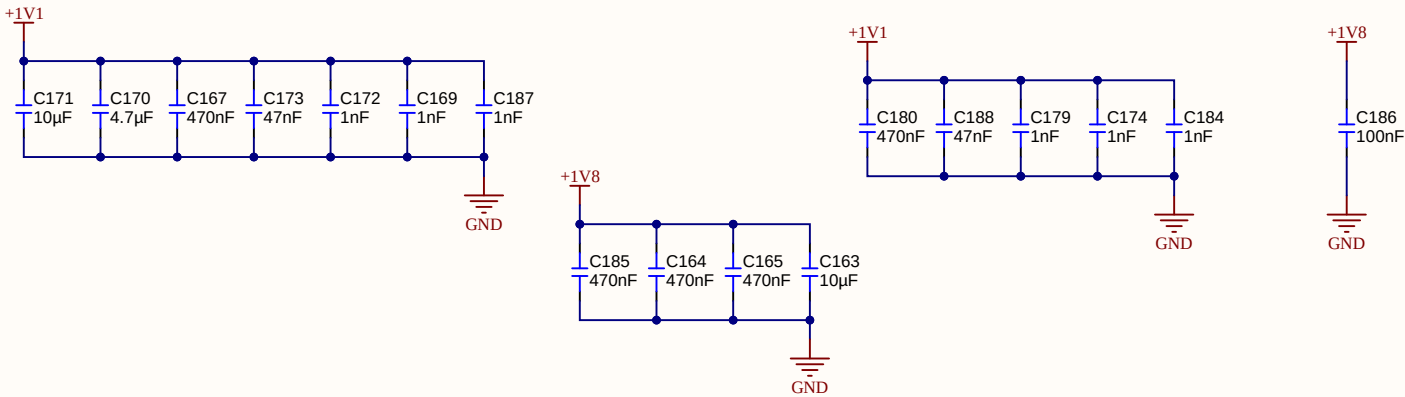


PS_DDR_CS and CKE signals connected to maintain backwards DDR compatibility.

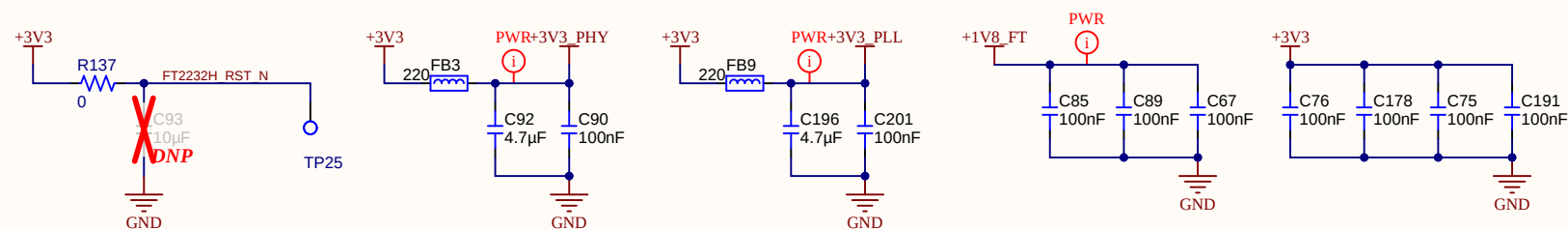
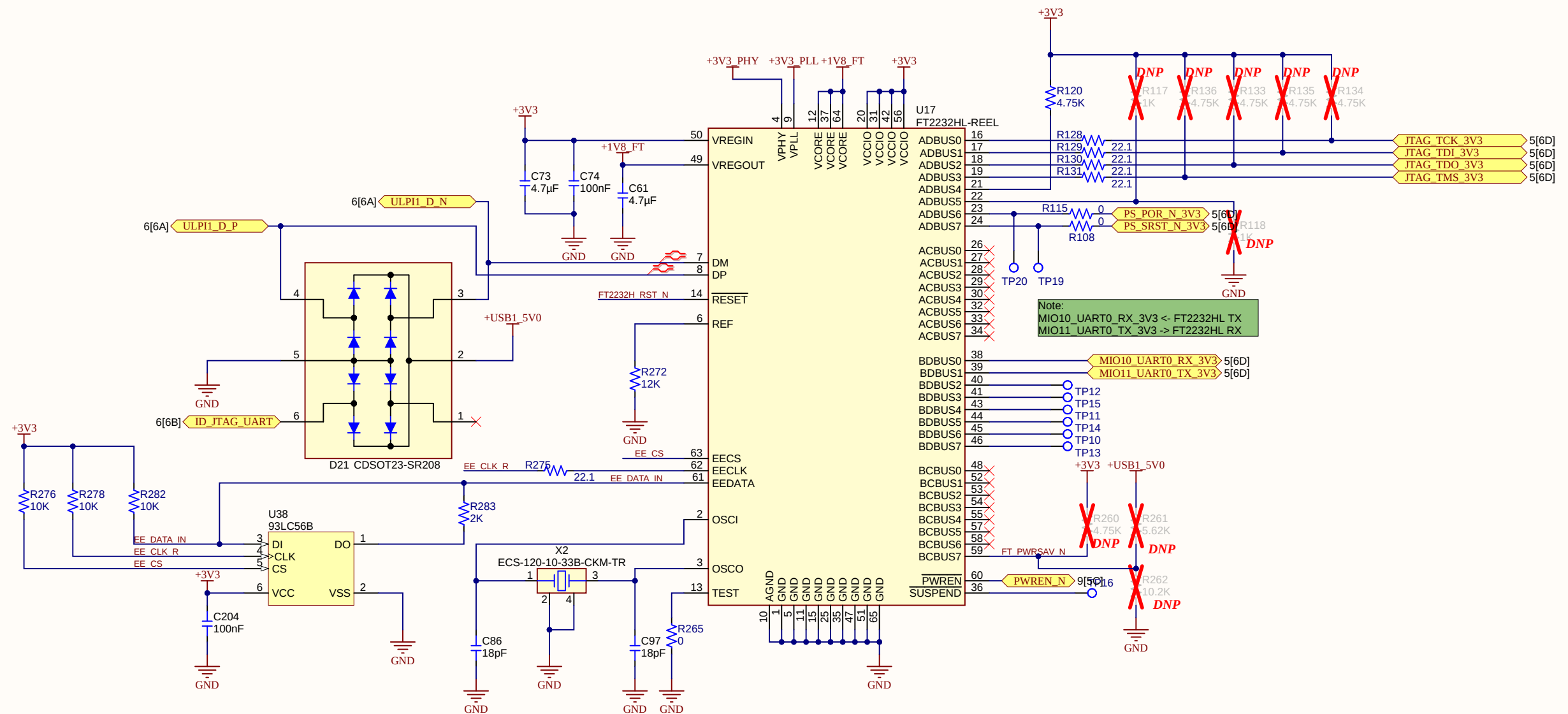
LAYOUT NOTES: 1) 40 Ohm Interface impedance. 2) Place DDR within 1 inch of Zynq device. 3) Place decoupling capacitors as close as possible to DDR device.

Note: Compatible with ISSI LPDDR4 16Gb, 2GB RAM

LAYOUT NOTE: Place ZQ resistor close to DDR IC.



JTAG & UART



SYZYG/Click Expansion

SYZYG TXR-2 MIO

RGA Resistor = 49.9k Ohm
Nominal RGA Voltag - 2.740V
I2C Address (7-bit) = 0x32

Layout Note: J1 & J2
Place J1 & J2 into double wide POD layout
with POD hanging off PCB

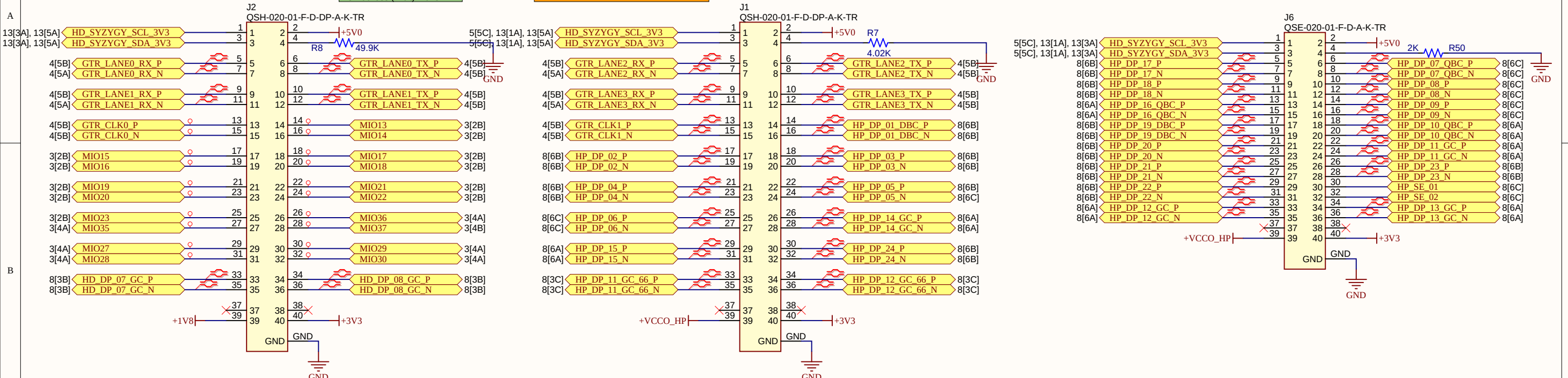
SYZYG TXR-2 PL

RGA Resistor = 4.02k Ohm
Nominal RGA Voltag - 0.933V
I2C Address (7-bit) = 0x3B

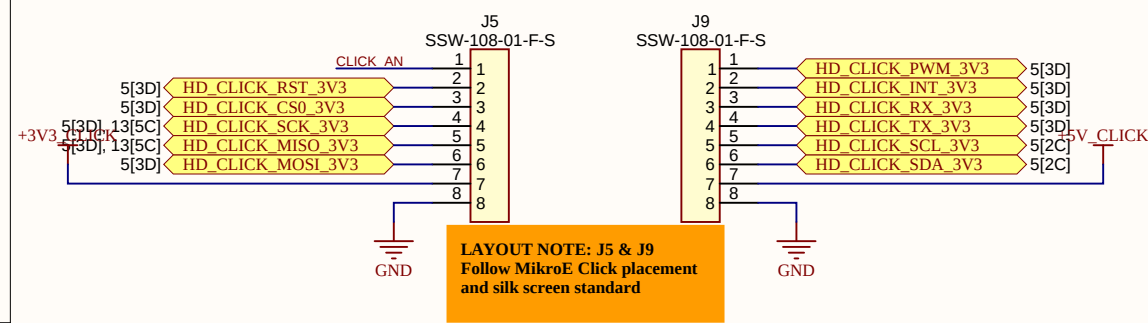
SYZYG Standard

RGA Resistor = 2k Ohm
Nominal RGA Voltag - 0.541V
I2C Address (7-bit) = 0x3D

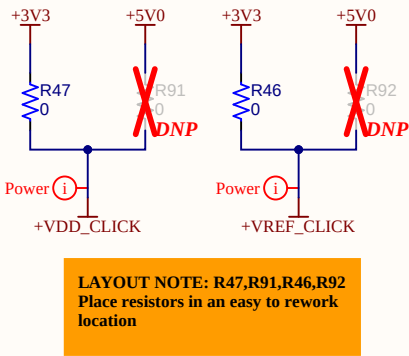
Layout Note: J6
Place J6 with POD hanging off PCB



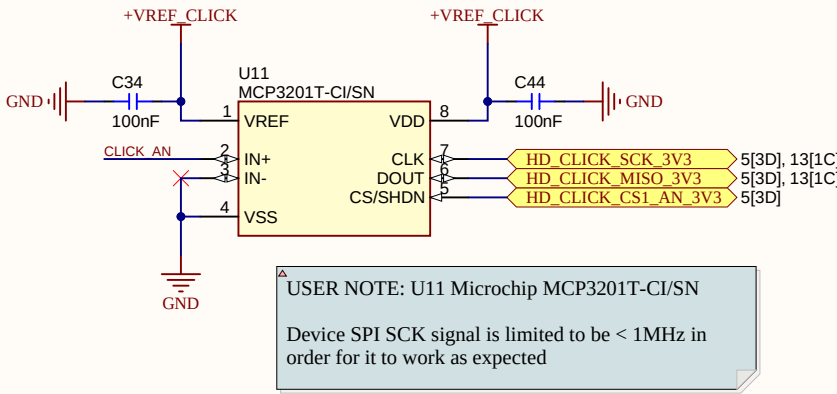
MikroE Click Site



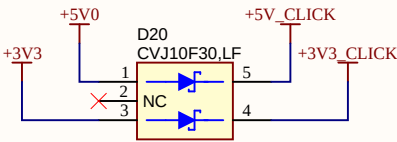
MikroE Click I/O Level



A/D Converter

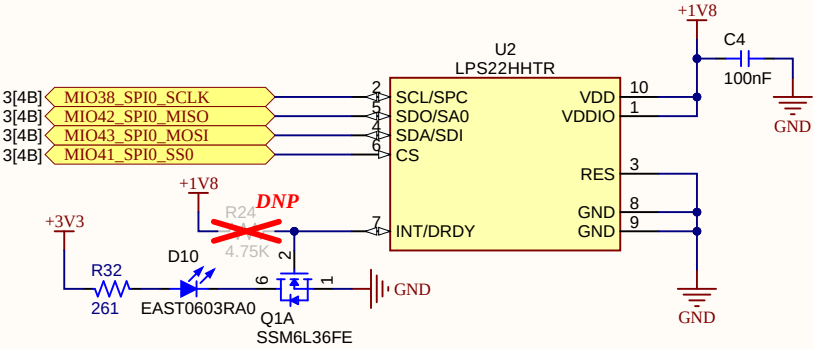


Click Site Voltage Protection

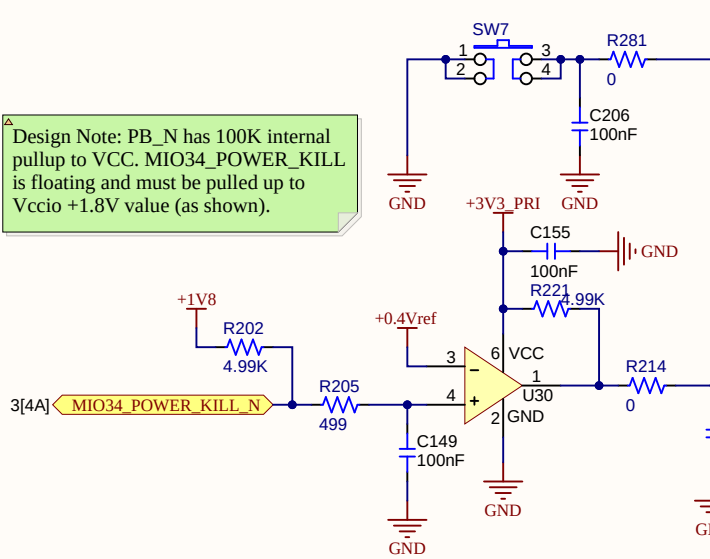


I2C & SPI Sensor, ON/OFF CONTROLLER

SPI Pressure Sensor

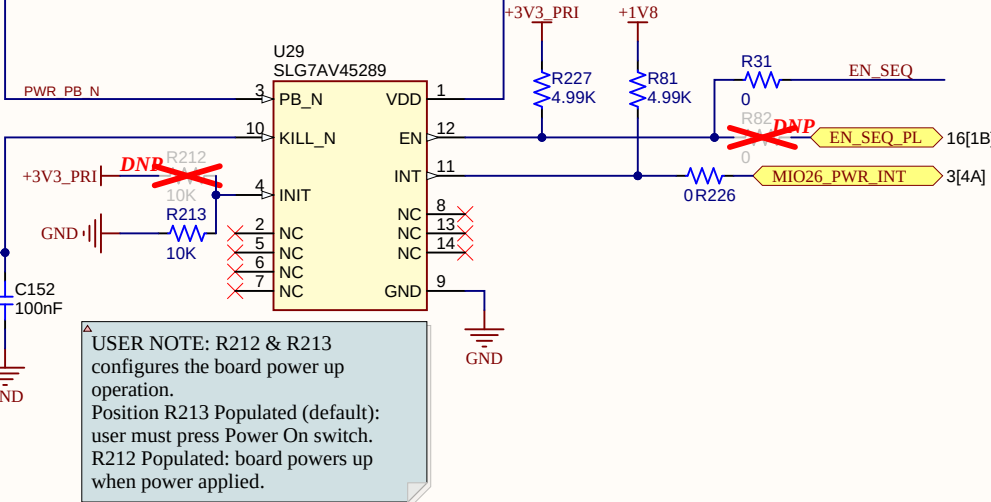


POWER BUTTON



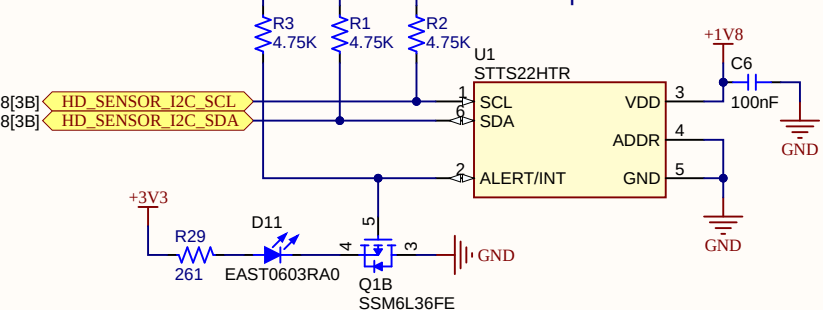
Design Note: PB_N has 100K internal pullup to VCC. MIO34_POWER_KILL is floating and must be pulled up to Vccio +1.8V value (as shown).

ON/OFF CONTROLLER

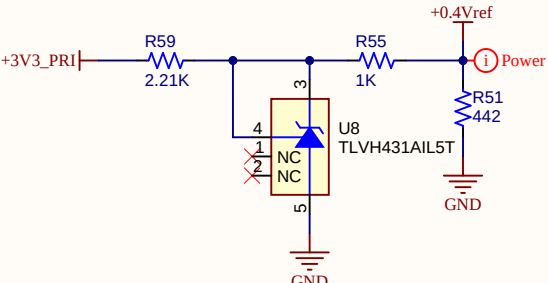


USER NOTE: R212 & R213 configures the board power up operation. Position R213 Populated (default): user must press Power On switch. R212 Populated: board powers up when power applied.

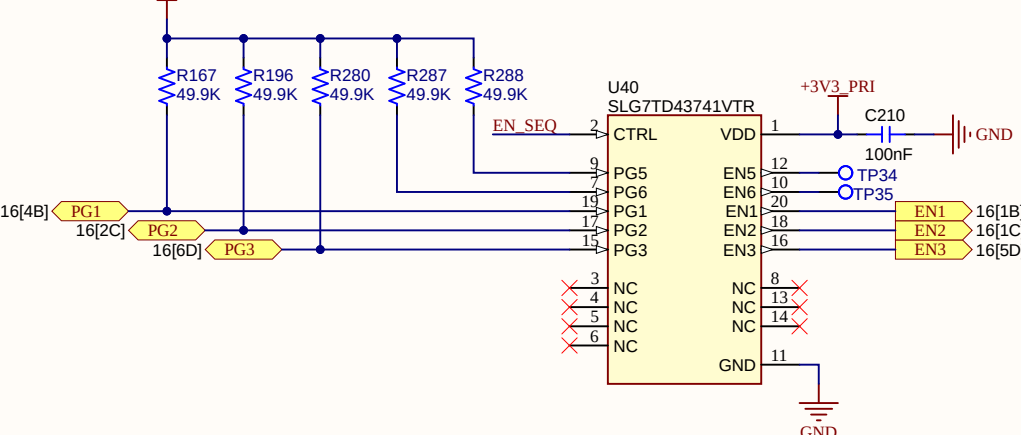
I2C Temperature Sensor



0.4V Vref

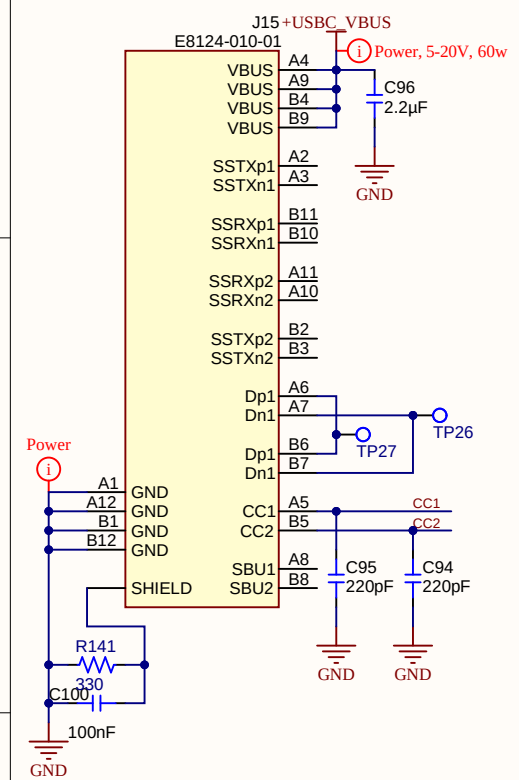


ON/OFF SEQUENCING

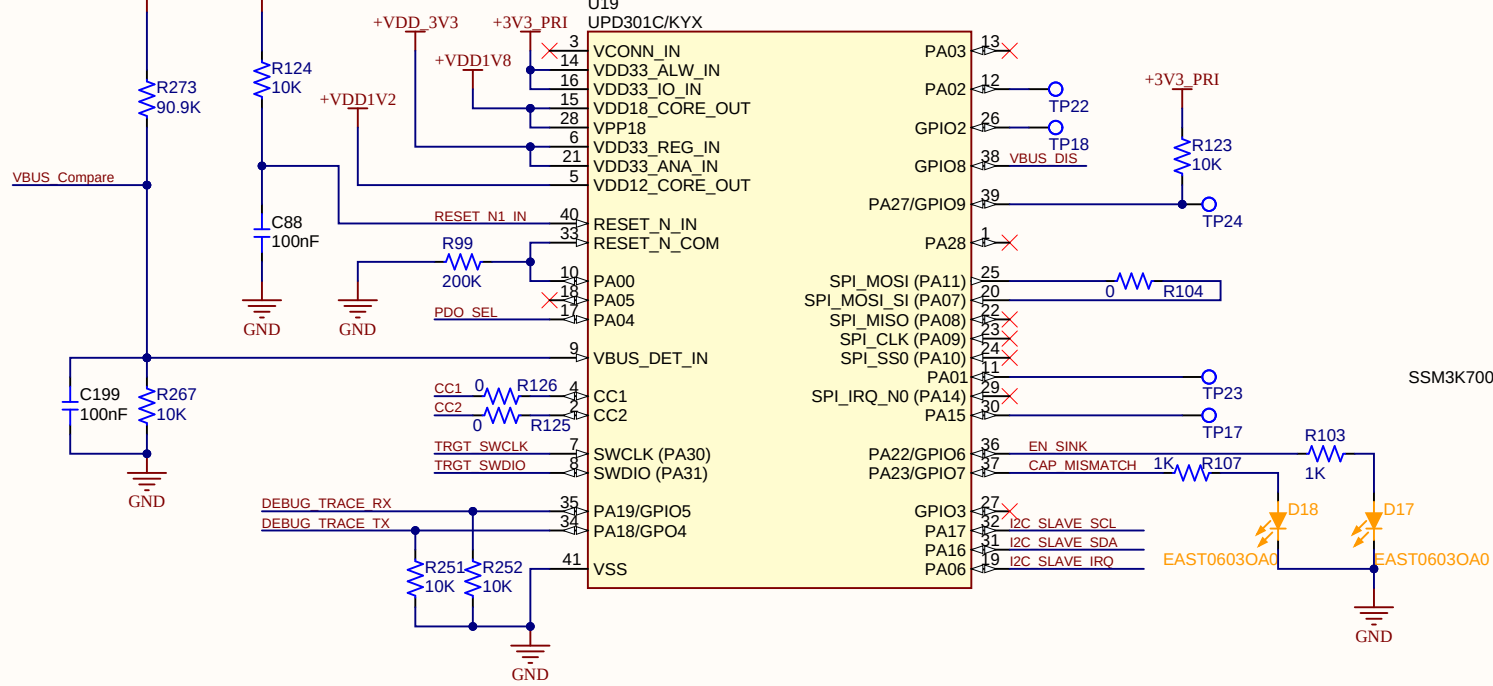


USB-C Power In

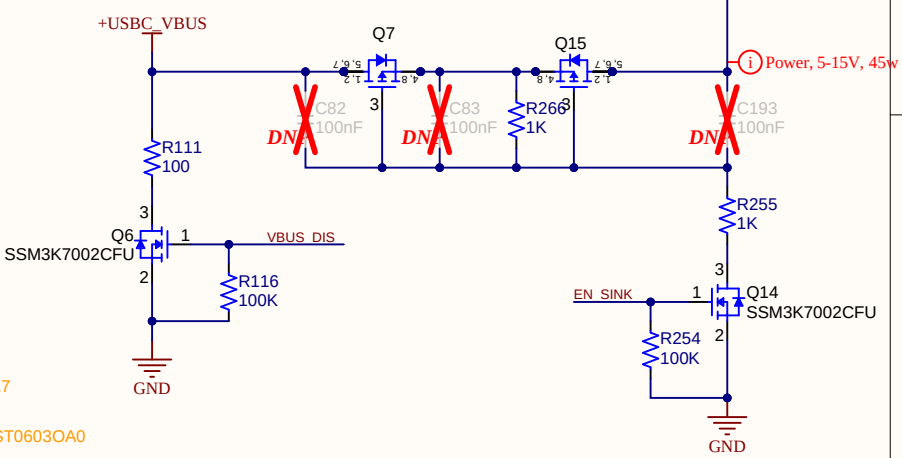
USB-Type C Power In Connector



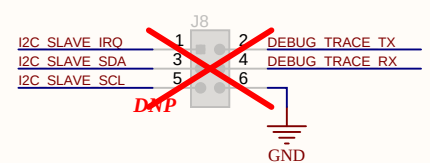
USB-Type C Power Controller



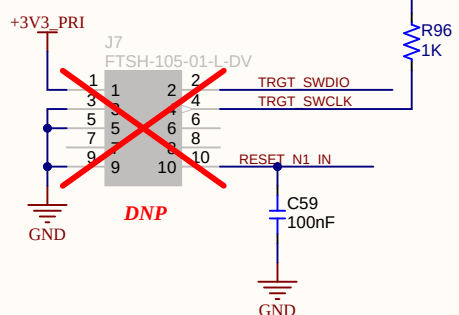
VBUS Sink Load Switch



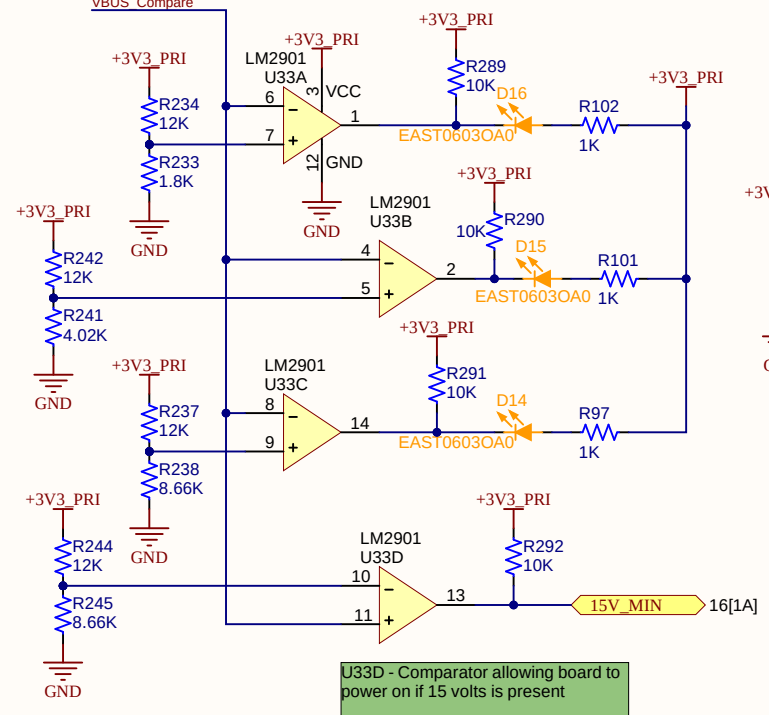
Debug Header



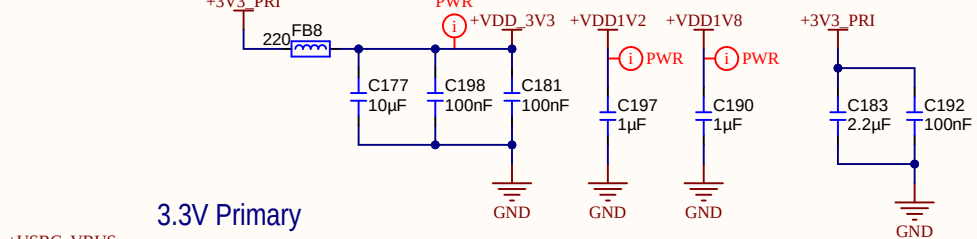
Programming Header



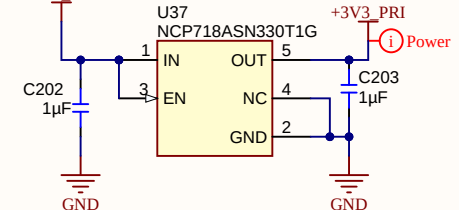
Volt Meter



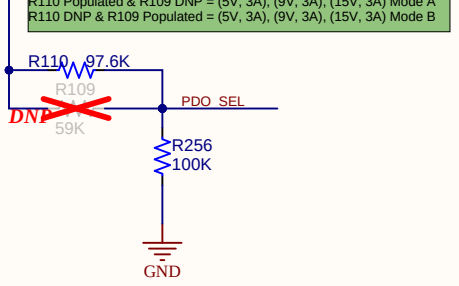
Power in Decoupling



3.3V Primary

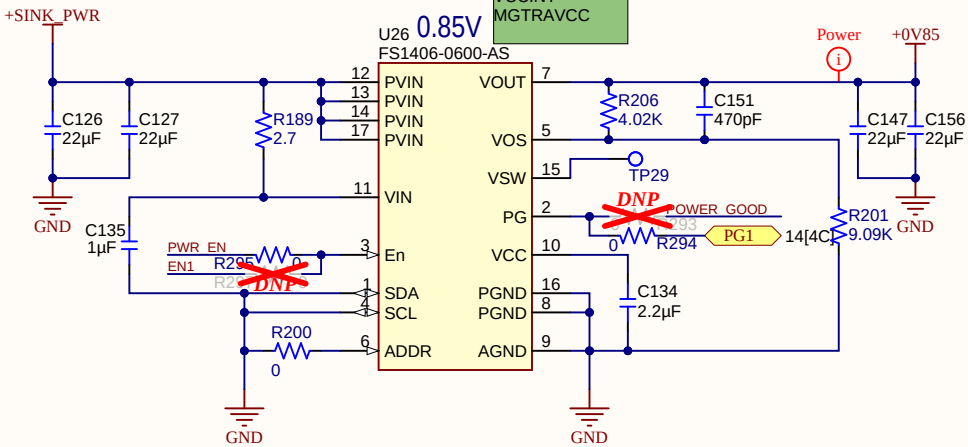
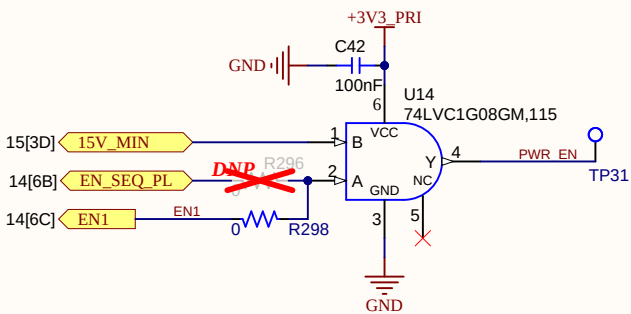


PDO Selection

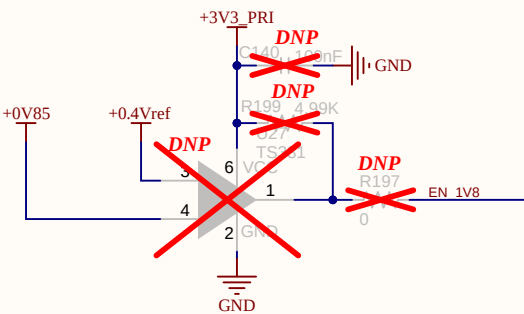


Power Supplies

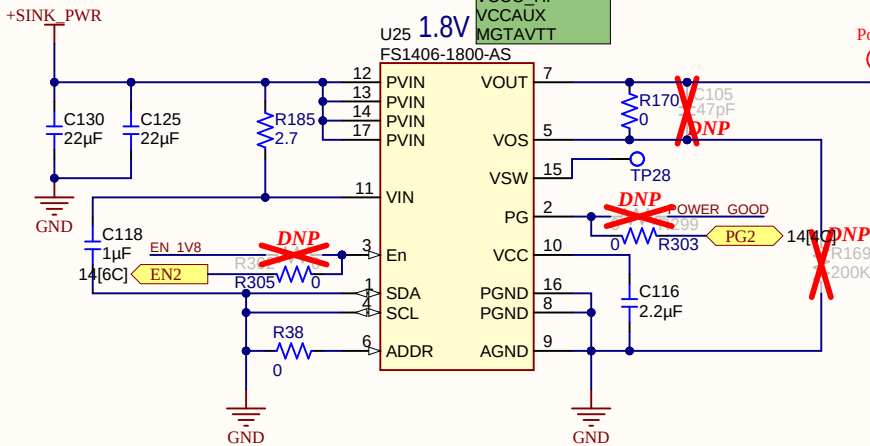
15V Min PWR On



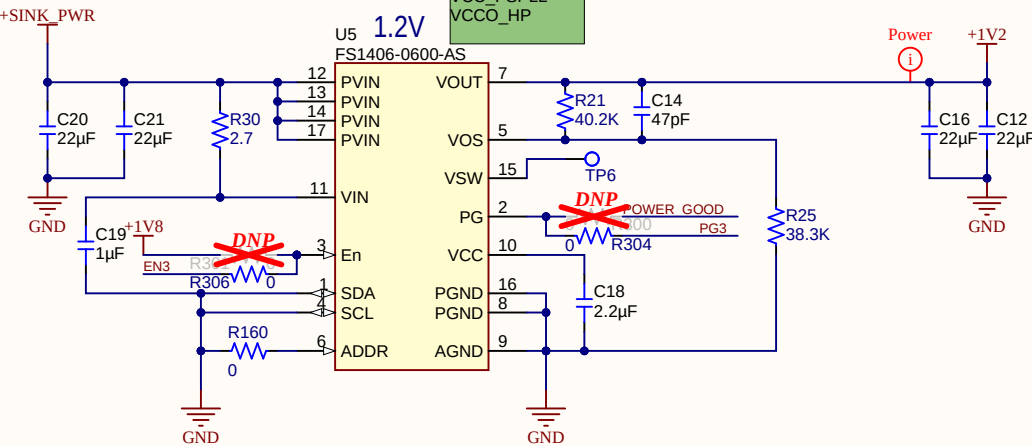
1.8V Enable



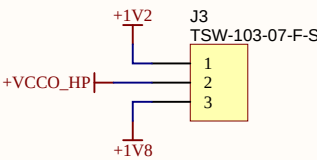
1.8V



1.2V

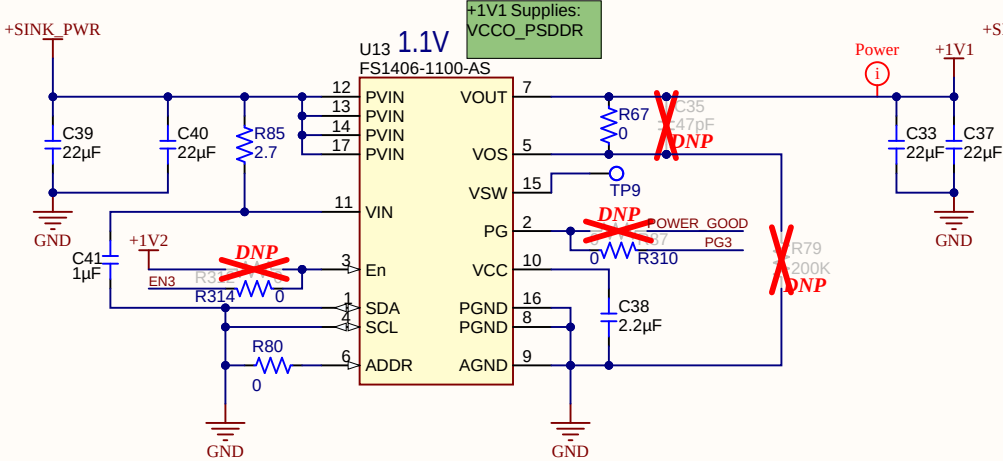


+VCCO_HP Voltage Selection

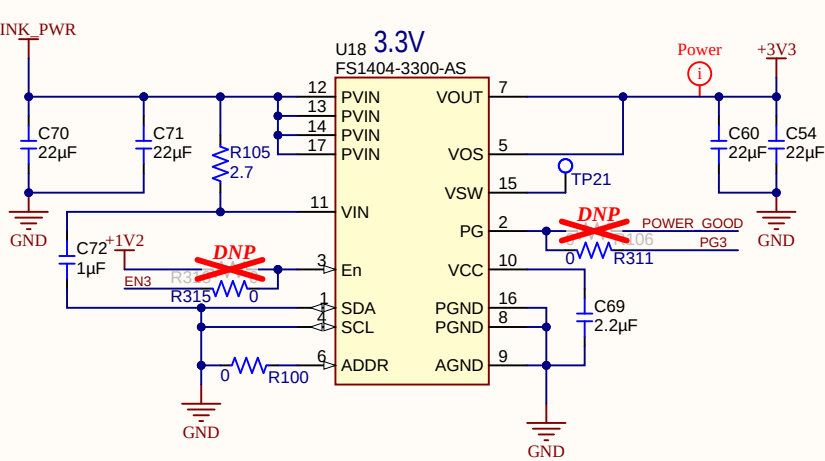


Jumper Postion	+VCCO_HP Voltage
1-2	1.2V
2-3	1.8V

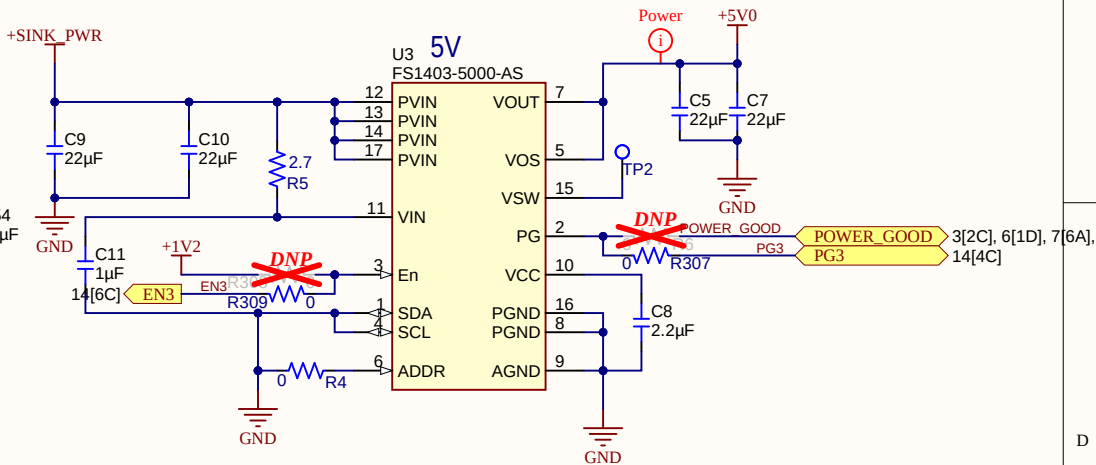
1.1V



3.3V



5V



Assembly:

Label1
BD-XXXX-XXXX-G
Label, Product

Label2

XXXXXXX
Label, Serial Number

ESD1

ESD Bag

Label_ESD1

Label, ESD

SS1

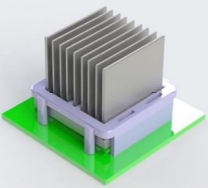
Trash Can-Silk Screen

Mechanicals:

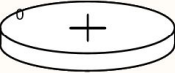
PCB


PCB PN (In Copper)

Heatsink

MECH1

EA-190-H095-T710

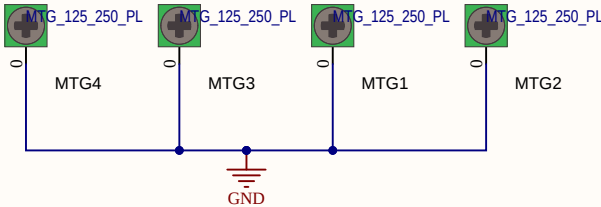
Battery

MECH2

CSY-CR2032

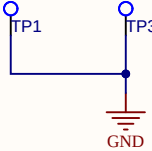
Fiducials:

FID2 FID3 FID1 FID4 FID6 FID5


Mounting Holes:



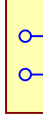
GND Test Points:



PCB Bumpers

BMPR1 BMPR2
SJ61A4 SJ61A4
BMPR3 BMPR4
SJ61A4 SJ61A4
BMPR5
SJ61A4

Shunt

SH1

SNT-100-BK-T

SD Cards

SD1

S416GSEJL-U3000-3
DNP

SD2

SDSDQAF3-064G-XI
DNP

Power Supply

MECH3

PSA-A45WM-U
DNP

USB Cables

MECH4

C06026-00013
DNP

MECH5

68784-0003
DNP